Product data sheet

1 Product profile

1.1 General description

Two planar PIN diodes in common cathode configuration in a SOT323 small SMD plastic package.

1.2 Features and benefits

- Two elements in common cathode configuration in a small SMD plastic package
- · Low diode capacitance
- · Low diode forward resistance
- AEC-Q101 qualified

1.3 Applications

· General RF applications

2 Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	anode (a1)		
2	anode (a2)	$\frac{3}{2}$	
3	common cathode	1 2 sot323_so Top view	1 2

3 Ordering information

Table 2. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
BAP51-05W	-	plastic surface-mounted package; 3 leads	SOT323		



4 Marking

Table 3. Marking

Type number	Marking code
BAP51-05W	%1W

5 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	continuous reverse voltage		-	50	V
I _F	continuous forward current		-	50	mA
P _{tot}	total power dissipation	T _{sp} ≤ 90 °C	-	240	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

6 Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point		250	K/W

7 Characteristics

Table 6. Characteristics

 T_i = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 50 mA	-	0.95	1.1	V
V _R	reverse voltage	I _R = 10 μA	50	-	-	V
I _R	reverse current	V _R = 50 V	-	-	100	nA
C _d	diode capacitance	f = 1 MHz (see Figure 1)		1		
		V _R = 0 V	-	0.4	-	pF
		V _R = 1 V	-	0.3	0.55	pF
		V _R = 5 V	-	0.2	0.35	pF
r _D	diode forward resistance	f = 100 MHz (see <u>Figure 2</u>)				
		I _F = 0.5 mA	[1] -	5.5	9	Ω
		I _F = 1 mA	[1] _	3.6	6.5	Ω
		I _F = 10 mA	[1] _	1.5	2.5	Ω
τL	charge carrier life time	when switched from I $_{F}$ = 10 mA to I $_{R}$ = 6 mA; R $_{L}$ = 100 $\Omega; measured$ at I $_{R}$ = 3 mA	-	550	-	ns
L _S	series inductance	I _F = 10 mA; f = 100 MHz	-	1.6	-	nH

^[1] Guaranteed on AQL basis; inspection level S4, AQL 1.0

Graphical data

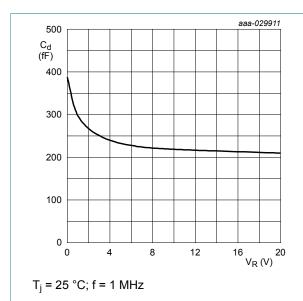
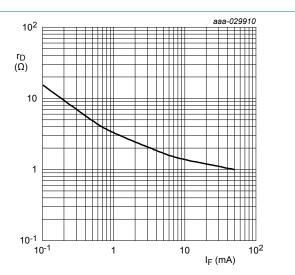
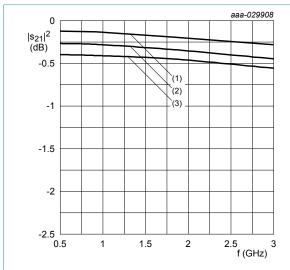


Figure 1. Diode capacitance as a function of reverse voltage (typical values)



 $T_i = 25 \, ^{\circ}C; f = 100 \, MHz.$

Figure 2. Diode forward resistance as a function of forward current (typical values)



Diode inserted in series with a 50 Ω strip line circuit and biased via the analyzer T-network. T_i = 25 °C; f = 1 MHz

- (1) $I_F = 10 \text{ mA}$
- (2) $I_F = 1 \text{ mA}$
- (3) $I_F = 0.5 \text{ mA}$

0 $|s_{21}|^2$ (dB) -20 -30 -50 └ 0.5 1.5 f (GHz)

Diode zero-biased and inserted in series with a 50 Ω strip line circuit and biased via the analyzer T-network. T_i = 25 °C; f = 1 MHz

Figure 3. Insertion loss $(|S_{21}|^2)$ of the diode as a function Figure 4. Isolation $(|S_{21}|^2)$ of the diode as a function of of frequency (typical values)

frequency (typical values)

9 Package outline

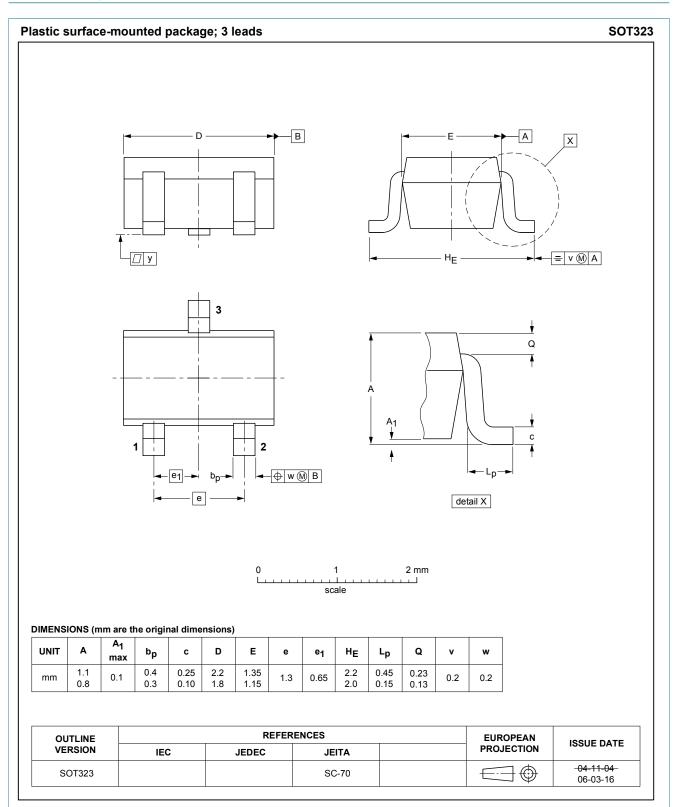


Figure 5. Package outline SOD323

10 Revision history

Table 7. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP51-05W v.2.1	20190208	Product data sheet	-	BAP51-05W v.2
Modifications:	aligned the title o	f the data sheet with the	description on the I	nternet
BAP51-05W v.2	20180323	Product data sheet	-	BAP51-05W v.1
Modifications:	 Section 1.2 "Features and benefits" has been updated. The "Legal information" pages have been updated. 			
BAP51-05W v.1	20010123	Product data sheet	-	-

11 Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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BAP51-05W

Silicon PIN diode

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